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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/077,777	02/20/2002	Shigeki Matsuda	111995	3646
25944 75	90 11/29/2005		EXAMINER	
OLIFF & BERRIDGE, PLC			WONG, EDNA	
P.O. BOX 1992	_		ART UNIT	PAPER NUMBER
ALEXANDRIA	, VA 22320		1753	

DATE MAILED: 11/29/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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-		Application No.	Applicant(s)	<u></u>
		10/077,777	MATSUDA ET AL.	
	Office Action Summary	Examiner	Art Unit	
		Edna Wong	1753	
 Period for	The MAILING DATE of this communication Reply	appears on the cover sheet	with the correspondence address	
WHICH - Extens after SI - If NO p - Failure Any rep	RTENED STATUTORY PERIOD FOR RIMEVER IS LONGER, FROM THE MAILING ions of time may be available under the provisions of 37 CF IX (6) MONTHS from the mailing date of this communication eriod for reply is specified above, the maximum statutory provided to reply within the set or extended period for reply will, by soly received by the Office later than three months after the property patent term adjustment. See 37 CFR 1.704(b).	G DATE OF THIS COMMUN FR 1.136(a). In no event, however, may n. eriod will apply and will expire SIX (6) MG statute, cause the application to become	IICATION. The reply be timely filed DNTHS from the mailing date of this communication. ABANDONED (35 U.S.C. § 133).	
Status				
1)⊠ F	Responsive to communication(s) filed on (09 November 2005.		
·		This action is non-final.		
	Since this application is in condition for allowed in accordance with the practice und		-	
Dispositio	n of Claims			
4) 🖂 (4) 5) 🗌 (6) 🖾 (7) 🔲 (6)	Claim(s) 1-15 is/are pending in the application of the above claim(s) is/are with Claim(s) is/are allowed. Claim(s) 1-15 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and	ndrawn from consideration.		
Applicatio	n Papers			
9) <u></u> ⊤	he specification is objected to by the Exar	miner.		
10)□ T	he drawing(s) filed on is/are: a)	accepted or b) objected to	by the Examiner.	
A	applicant may not request that any objection to	the drawing(s) be held in abey	ance. See 37 CFR 1.85(a).	
	Replacement drawing sheet(s) including the co he oath or declaration is objected to by th			
Priority un	der 35 U.S.C. § 119			
a)⊠ 1 2 3	cknowledgment is made of a claim for form All b) Some * c) None of: Certified copies of the priority document Copies of the certified copies of the application from the International Bute the attached detailed Office action for a	nents have been received. nents have been received in priority documents have bee reau (PCT Rule 17.2(a)).	Application No n received in this National Stage	
Attachment(s	•	_		
2) Notice (3) Informa Paper N	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948 ation Disclosure Statement(s) (PTO-1449 or PTO/SE No(s)/Mail Date	Paper No	Summary (PTO-413) o(s)/Mail Date. <i>November 21, 2005</i> . Informal Patent Application (PTO-152)	

Art Unit: 1753

This is in response to the Amendment dated November 9, 2005. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Response to Arguments

Claim Rejections - 35 USC § 103

Claims **1-15** have been rejected under 35 U.S.C. 103(a) as being unpatentable over **Matsuda** (US Patent No. 5,645,706).

The rejection of claims 1-15 under 35 U.S.C. 103(a) as being unpatentable over Matsuda is as applied in the Office Actions dated January 15, 2004, August 24, 2004 and May 9, 2005 and incorporated herein. The rejection has been maintained for the following reasons:

Applicants state that in contrast to the recited claim language, Matsuda specifically discloses a treatment bath that is not substantially free of metal ions, other than those which are a component of a film which will form sludge.

Applicant state that Matsuda clearly discloses metal ions other than those which are a component of the film in the treatment bath and form sludge.

Applicants state that the treatment bath of Matsuda contains metal ions other than those which are component of a film. Accordingly, Matsuda fails to disclose a treatment bath that is substantially free of metal ions, other than those which are a component of a film which would form a sludge. Therefore, Matsuda fails to

disclose each and every feature recited in the rejected claims as amended.

In response, Matsuda teaches that the chemical treatment solutions used are aqueous phosphate solutions containing <u>coat-forming metal ions</u> such as iron, manganese, nickel, calcium, zinc, etc. (col. 2, lines 50-53). These metal ions are a component of the film since they are coat-forming metal ions (see Chemical Equation 4, col. 3, line 5, where the coat-forming metal ions are zinc or iron).

Matsuda teaches that the statement that the phosphate chemical treatment bath contains no solid matter other than the unavoidable components is used to mean that the bath is free of any sludge which might cause energy instability, that is, the bath is free of suspended particles which are reactive and could interfere with the reaction (col. 6, lines 38-43).

This teaching would have suggested to one having ordinary skill in the art that the bath is substantially free of metal ions, other than those which are a component of a film which will form sludge.

The sludge that is formed in the method disclosed by Matsuda is unavoidable sludge, not from "other metal ions" but from the ions already present in the phosphate chemical treatment bath as the chemical reactions in the chemical treatment bath shifts (col. 3, lines 7-15; and col. 8, lines 28-46).

Applicants state that Matsuda relates to an electrolytic treatment using a non-

electrolytic treatment bath which contains metal ions other than those which are a component of a film. Therefore, a sludge is inevitably formed as evidenced by the recitation of claim 1 which recites that circulating and filtering of the phosphate chemical treatment solution is provided to remove energy destabilizing sludge.

In response, Matsuda teaches that the statement that the phosphate chemical treatment bath contains no solid matter other than the unavoidable components is used to mean that the bath is free of any sludge which might cause energy instability, that is, the bath is free of suspended particles which are reactive and could interfere with the reaction (col. 6, lines 38-43).

This teaching would have suggested to one having ordinary skill in the art that the bath is substantially free of metal ions, other than those which are a component of a film which will form sludge.

The sludge that is formed in the method disclosed by Matsuda is unavoidable sludge, not from "other metal ions" but from the ions already present in the phosphate chemical treatment bath as the chemical reactions in the chemical treatment bath shifts (col. 3, lines 7-15; and col. 8, lines 28-46).

Matsuda teaches that circulating the treatment bath restores the state of equilibrium of the phosphate ion in the solution, stabilizes the thermodynamic energy state in the solution, and suppresses the deposition of sludge in the solution phase (col. 7, line 64 to col. 8, line 46). Filtering the treatment bath removes the produced sludge (col. 8, lines 60-65).

Matsuda does not want to produce sludge (col. 6, lines 40-41; col. 7, lines 39 and 44-45; col. 8, lines 45-46; and col. 9, lines 21-22).

Matsuda teaches that filtering would have removed energy-destabilizing sludge, *if any*, therefrom (col. 32, claim 1). A sludge is not inevitably formed as recited in claim 1.

Response to Amendment

Claim Rejections - 35 USC § 112

Claims **1-15** are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention.

Claim 1

lines 13-14, recites "the treatment bath is substantially free of metal ions, other than those which are a component of <u>a film</u> which will form a sludge".

Applicants' specification discloses that the effect is on <u>the film</u> and not a film (page 4, lines 9-13).

lines 17, recites "and is used to monitor treatment of the bath".

Applicants' specification does not disclose monitoring treatment of the bath.

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II. Claims 1-15 are rejected under 35 U.S.C. 112, second paragraph, as being

indefinite for failing to particularly point out and distinctly claim the subject matter which

applicant regards as the invention.

Claim 1

line 17, recites "and is used to monitor treatment of the bath". There is no

method step of treating the treatment bath in claim 1. Thus, it is unclear how the bath is

being treated, in order for this treatment to be monitored.

Claim 8

line 2, "the complex with the phosphoric acid ..." lacks antecedent basis.

Claim 9

line 5, it appears that the "electrolytic treatment" is the same as that recited in

claim 9, line 4. However, it is unclear if it is. If it is, then it is suggested that the word --

the -- be inserted after the word "out".

line 8, it appears that "the N₂O₄ gas formed" is the same as the N₂O₄ gas

generated recited in claim 9, line 2. However, it is unclear if it is. If it is, then it is

suggested that the word "formed" be amended to the word -- generated --.

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Edna Wong whose telephone number is (571) 272-1349. The examiner can normally be reached on Mon-Fri 7:30 am to 4:00 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nam Nguyen can be reached on (571) 272-1342. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Edna Wong
Primary Examiner
Art Unit 1753

EW November 22, 2005